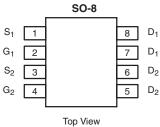




Dual N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^{a, e}	Q _g (Typ.)			
	0.016 at V _{GS} = 10 V	8				
30	0.018 at V _{GS} = 4.5 V	8	19			
	0.024 at V _{GS} = 2.5 V	8				



Ordering Information: Si4922BDY-T1-E3 (Lead (Pb)-free)

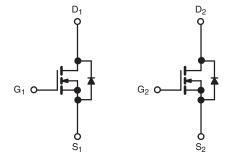
Si4922BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- 100 % R_g and UIS tested
- Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS TA	= 25 °C, unless other	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage	V _{GS}	± 12	v	
	T _C = 25 °C		8 ^e	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1 , \square	8 ^e	
Continuous Diain Current (1) = 150°C)	T _A = 25 °C	I _D	8 ^{b, c, e}	
	T _A = 70 °C		6.6 ^{b, c}	
Pulsed Drain Current (10 µs Pulse Width)	•	I _{DM}	35	Α
Source-Drain Current Diode Current	T _C = 25 °C	1	2.5	
Source-Drain Current Diode Current	T _A = 25 °C	I _S	1.7 ^{b, c}	
Pulsed Sorce-Drain Current	I _{SM}	35		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15	
Single-Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	11.2	mJ
	T _C = 25 °C		3.1	
Marian on Davies Disables	T _C = 70 °C		2	w
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^{b, c}	VV
	T _A = 70 °C		1.28 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 50 to 150	°C	

THERMAL RESISTANCE RATINGS						
		Lir	nit			
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	50	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	40	C/VV	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 110 °C/W.
- e. Package Limited.

Si4922BDY

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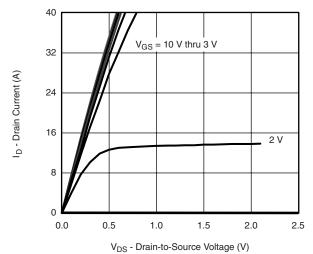
SPECIFICATIONS $T_J = 25 ^{\circ}C$, UParameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	Symbol	rest conditions	IVIIII.	тур.	IVIAA.	Unit	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30		1	V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J		- 00	35		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 4.6		mV/°C	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6	7.0	1.8	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	0.0		100	nA	
Care Body Learnage	.055	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	11/4	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α	
		$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		0.0135	0.016		
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.0145	0.018	Ω	
	` ´	$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.018	0.024		
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 5 \text{ A}$		30		S	
Dynamic ^a	•			l .			
Input Capacitance	C _{iss}			2070			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		255		pF	
Reverse Transfer Capacitance	C _{rss}			135			
Total Cata Chausa		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		41	62	nC	
Total Gate Charge	Q_g			19	29		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		3.5			
Gate-Drain Charge	Q_{gd}			3.7			
Gate Resistance	R_{g}	f = 1 MHz		1.8	3	Ω	
Turn-On Delay Time	t _{d(on)}			7	14		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		27	41		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 5$ A, $V_{GEN}=10$ V, $R_g=1$ Ω		31	47		
Fall Time	t _f			8	15		
Turn-On Delay Time	t _{d(on)}			13	25	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		53	80		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		68	102		
Fall Time	t _f	-		54	81		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.5	A	
Pulse Diode Forward Current ^a	I _{SM}				35	_ A	
Body Diode Voltage	V_{SD}	I _S = 1.7 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			32	48	ns	
Body Diode Reverse Recovery Charge	Q_{rr}	1 17 A 41/4 100 A / 1 25 20		21	32	nC	
Reverse Recovery Fall Time	t _a	$I_F = 1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13			
Reverse Recovery Rise Time	t _b	1		19		ns	

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

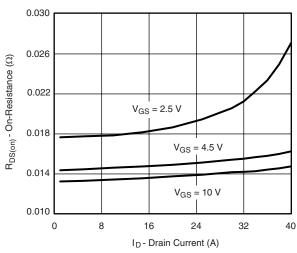
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



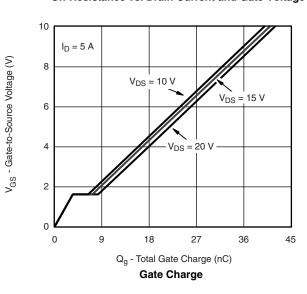
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

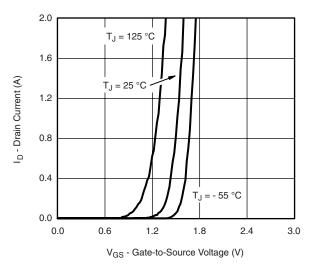


Output Characteristics

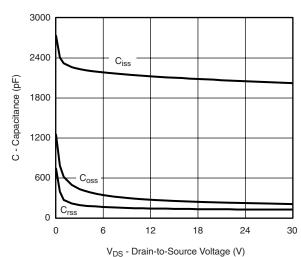


On-Resistance vs. Drain Current and Gate Voltage

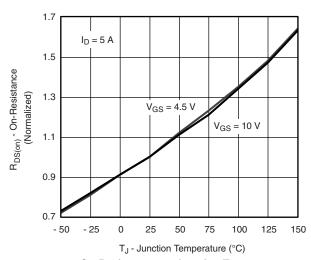




Transfer Characteristics



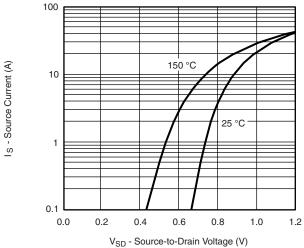
Capacitance



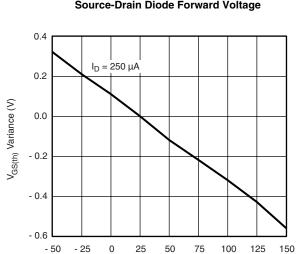
On-Resistance vs. Junction Temperature

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage

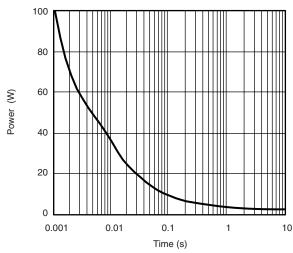


T_J - Temperature (°C)

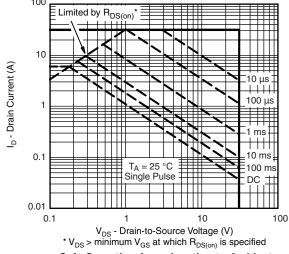
Threshold Voltage

0.10 I_D = 5 A 0.08 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) 0.06 0.04 125 °C 0.02 25 °C 0.00 2 0 1 5 6 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

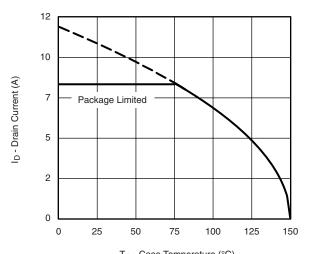


Single Pulse Power, Junction-to-Ambient



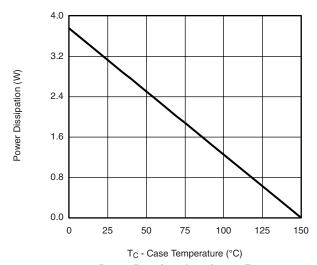


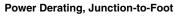
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

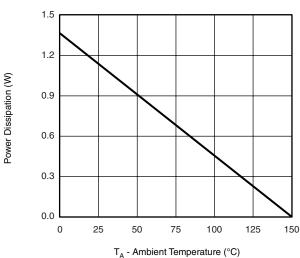


T_C - Case Temperature (°C)

Current Derating*







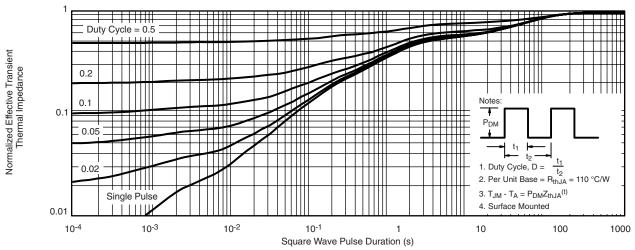
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

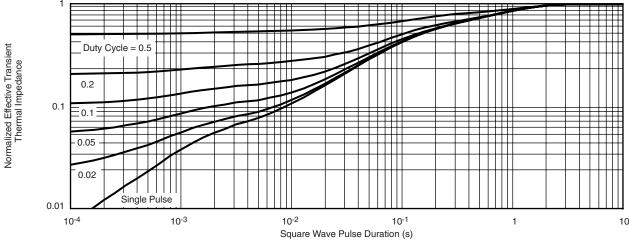
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	50 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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